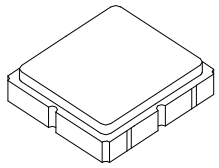
SF2008D

930.5 MHz SAW Filter

- ***RF Filter for Pager Applications***
- ***High Rejection Out of Band***
- ***Complies with Directive 2002/95/EC (RoHS)***



SM3838-6

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	0	dBm
Maximum DC Voltage Between Any Two Terminals	30	VDC
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s	

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_C	1		930.5		MHz
Passband Insertion Loss, 928.5 to 932.5 MHz	IL_{MAX}				4.5	dB
Passband Amplitude Ripple, 928.5 to 932.5 MHz		1, 2			2.0	dB_{P-P}
Rejection Referenced to IL_{MAX}						
400 to 880 MHz		1, 2, 3	35			dB
884.8 to 890.2 MHz			40			
906.8 to 911.2 MHz			30			
980 to 1300 MHz			35			
Operating Temperature Range	T_A	1	-20		+70	°C
Input Impedance at f_C	50 - j57 ohm					
Output Impedance at f_C	50 - j57 ohm					

Case Style	SM3838-6 3.8 x 3.8 mm Nominal Footprint
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	455, YWWS
Standard Reel Quantity Reel Size 7 Inch	1000 Pieces/Reel
Reel Size 13 Inch	3000 Pieces/Reel

Electrical Connections

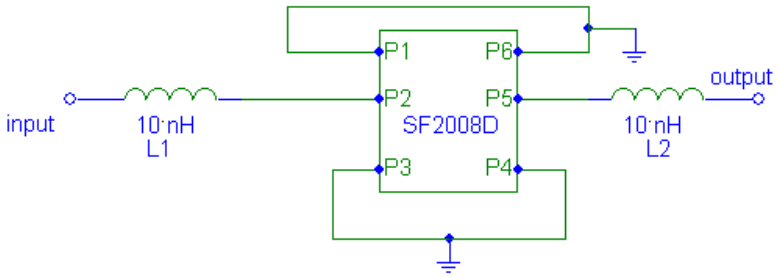
Connection	Terminals
Port 1	2
Port 2	5
Case Ground	All others

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

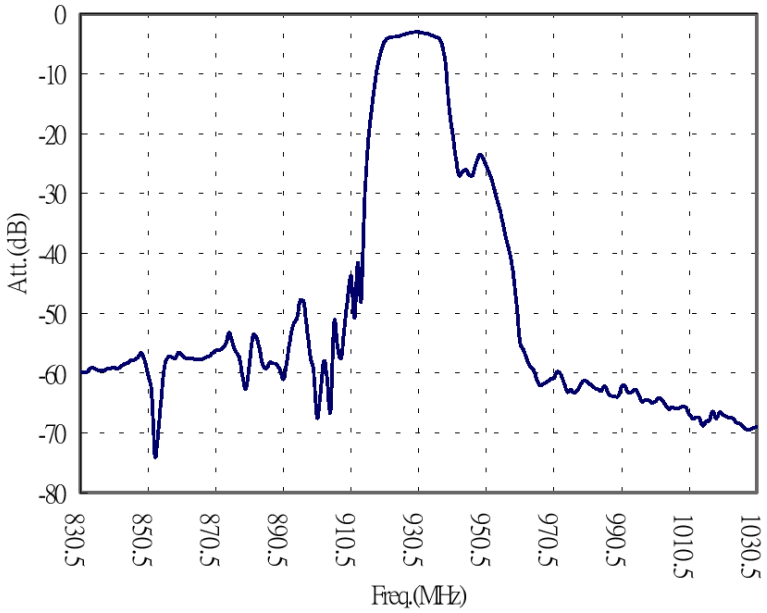
Notes:

1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
3. Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
5. The design, manufacturing process, and specifications of this filter are subject to change.
6. Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
7. US and international patents may apply.
8. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered

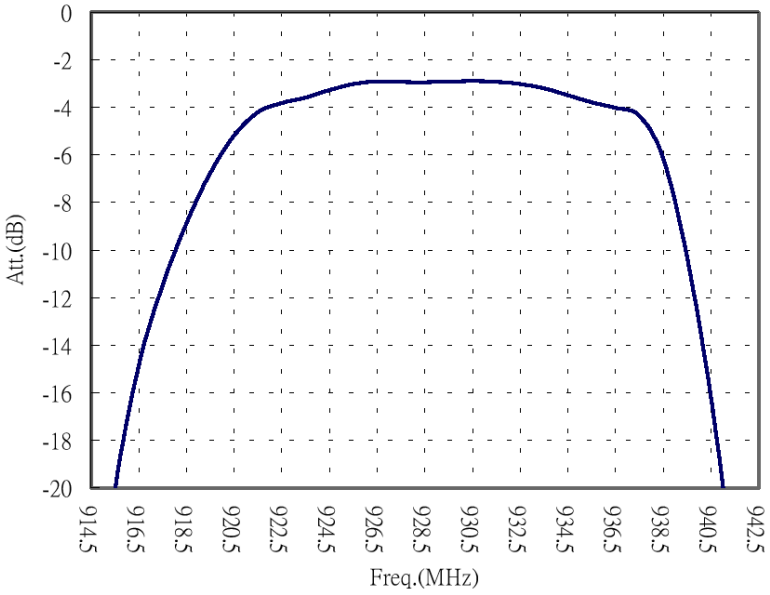
Matching Circuit



S21 Wide Span



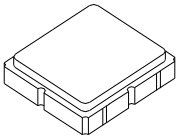
S21 Narrow Span

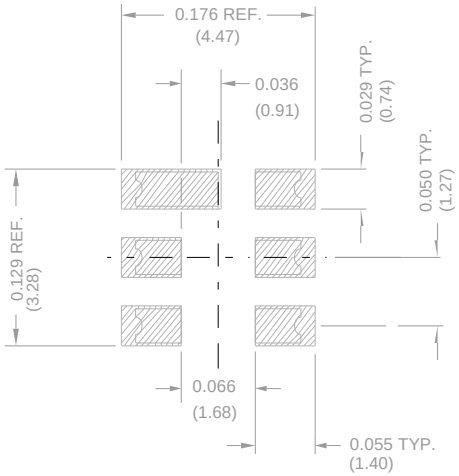


SM3838-6 Case

6-Terminal Ceramic Surface-Mount Case

3.8 X 3.8 mm Nominal Footprint





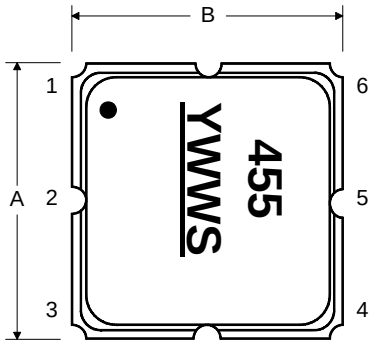
PCB Footprint

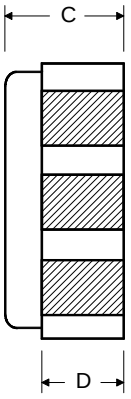
Case Dimensions						
Dimension	**mm**			**Inches**		
	Min	**Nom**	**Max**	**Min**	**Nom**	**Max**
A	3.60	3.80	4.0	0.14	0.15	0.16
B	3.60	3.80	4.0	0.14	0.15	0.16
C	1.30	1.50	1.70	0.05	0.06	0.067
D	0.95	1.10	1.25	0.037	0.043	0.05
E	2.39	2.54	2.69	0.090	0.10	0.110
G	0.90	1.0	1.10	0.035	0.04	0.043
H	1.90	2.0	2.10	0.75	0.08	0.83
I	0.50	0.6	0.70	0.020	0.024	0.028
J	1.70	1.8	1.90	0.067	0.07	0.075

Electrical Connections		
Connection		**Terminals**
Port 1	Single-ended Input	2
Port 2	Single-ended Output	5
	Ground	All others
Single-ended Operation Only		
Dot indicates Pin 1		

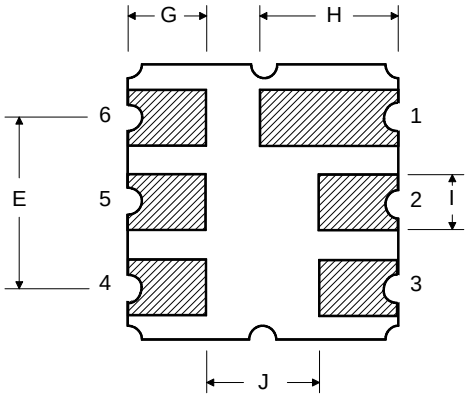
Materials	
Solder Pad Plating	0.3 to 1.0 µm Gold over 1.27 to 8.89 µm Nickel
Lid Plating	2.0 to 3.0 µm Nickel
Body	Al_2O_3 Ceramic
Pb Free	

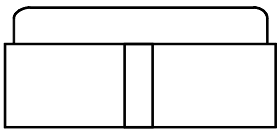
TOP VIEW



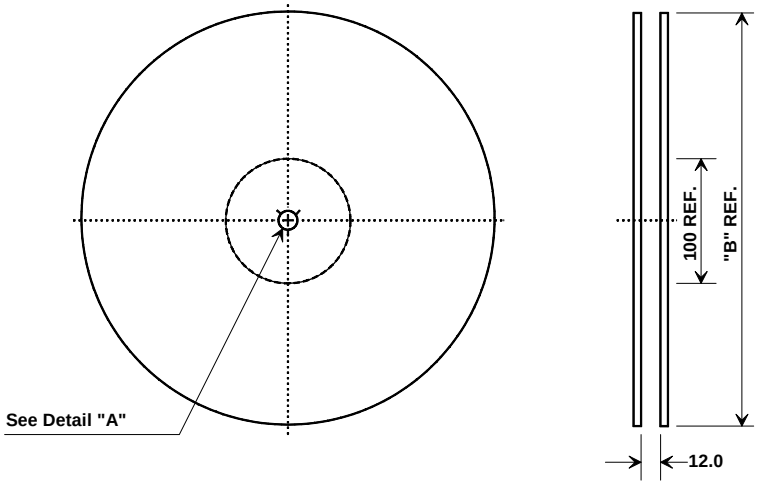


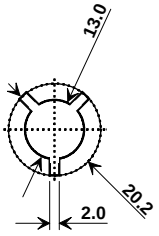
BOTTOM VIEW





Tape and Reel Specifications





"B " Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	1000
13	330	3000

COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	4.25 mm
Bo	4.25 mm
Ko	1.30 mm
Pitch	8.0 mm
W	12.0 mm